# 3W HI-POWER LED SPECIFICATION

# HPF8b-45K3RBx



Drawn by	Checked by	Approved by



REV:A



## **HUEY JANN ELECTRONICS INDUSTRY CO., LTD.**

HUEY JANN High Power 3W LED is made of hi-eff AS/TS AllnGaP chips with precise package technique which makes excellent heat dissipation to reach the advantages of high luminous efficiency, low decay, and long endurance. Now we have these colors available: red, green, blue, white, yellow and infrared.

#### **FEATERUS**

- Instant light
- Long operating life
- Superior ESD defense
- Low voltage DC operated
- More energy efficient than incandescent and most halogen lamps

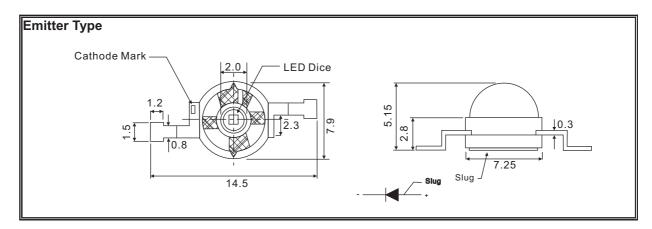
#### **TYPICAL APPLICATIONS**

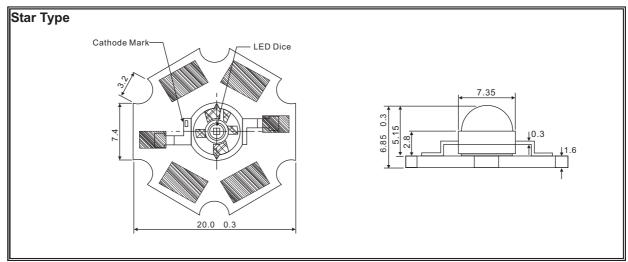
- Architectural detail lighting
- Portable flashlight
- Reading lights
- Medical applications
- LCD backlights
- Beacon lights
- Decoration lights



## **HUEY JANN ELECTRONICS INDUSTRY CO., LTD.**

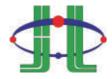
#### **PACKAGE DIMENSIONS:**





#### NOTE:

- 1.All dimensions are in millimeter.
- 2.Lead spacing in measured where the lead emerge from the package.
- 3.prodruded resin under flange is 1.5mm max.
- 4.specifications are subject to change without notice.
- 5. Tolerance is 0.3mm unless otherwise noted.
- 6.Driving LED without heat sinking device is forbidden.
- 7.It is strongly recommended that the temperature of lead be not higher than 55°C.
- 8. Proper current derating must be observed to maintain junction temperature below the maximum.
- 9.LEDs are not designed to be driven in reserve bias.



## **HUEY JANN ELECTRONICS INDUSTRY CO., LTD.**

#### **BABSOLUTE MAXIMUM RATINGS**

TA=25°C

PARAMETER	SYMBOL	MAX. RATING	UNIT	
Continuous Forward Current	IF	700	mA	
Peak Forward Current *1	IFM	1000	mA	
Electrostatic Discharge (HBM)	ESD	4000	V	
LED Junction Temperature	Tj	125	°C	
Operating Temperature	Topr	-40 ~ +110	°C	
Storage Temperature	Tstg	-40 ~ +120	°C	
Reflow Soldering (preheat 150-180°C 60-120sec, soldering temp 260°C 10sec)				

<sup>\*1.</sup>Duty Ratio=0.1%,Pulse Width=10us.



## **HUEY JANN ELECTRONICS INDUSTRY CO., LTD.**

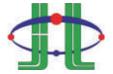
<sup>\*2.</sup>Iron soldering high temperature will not cause damage to the dice. But be aware of the high temperature will not only make the epoxy soften but also cause the lead moving and the gold wire broken and even open. So before returning to the normal temperatures PLEASE AVOID any serious pressure on the top of epoxy and lead.

## **BELECTRIC-OPTICAL CHARACTERISTICS**

TA=25°C

PARAMETER	SYMBOL	TEST CONDITION	MIN	TYP	MAX	UNIT
View Angle of Half Power	201/2	· IF=700mA		100		deg
Forward Voltage	VF	IF=700MA		2.6	2.8	V
Reverse Current	IR	VR=5V			15	$\mu$ A
Luminous Intensity	IV			107		lm
Peak Emission Wavelength	λр			635		nm
Dominate Wave Length *	λ d(HUE)			625		nm
Spectrum Width Of Half Valve	Δλ	IF=700mA		25		nm
Thermal Resistance Junction To Case	R heta J-C			13		°C/W
Thermal Resistance Junction To Case With Star Type Heat Sink	$R\hspace{.01in} heta_{\hspace{.01in}J-C}$			17		°C/W
Temperature Coefficient Of Forward Voltage	$\triangle V_F / \triangle T$			-2		mV/°C

<sup>\*.</sup> The dominate wavelength ,  $\lambda$  d, is derived from the CIE Chromaticity Diagram and represents the color of the device.



# **HUEY JANN ELECTRONICS INDUSTRY CO., LTD.**

# **PRELIABILITY TEST**

# > Endurance Test

Test Item	Reference Sta	andard	Test Conditions	Result
	MIL-STD-750:1026	3	Connect with a power if=700mA	
Operation Life	MIL-STD-883:1005	5	Ta=Under room temperature	0/22
	JIS-C-7021 :B	3-1	Test Time=1,000hrs	
High Temperature High Humidity Storage	MIL-STD-202:103B JIS-C-7021 :B		Ta=+85°C 5°C RH=80% ~ 85% Test Time=1,000hrs	0/22
High Temperature Storage	MIL-STD-883:1008 JIS-C-7021 :B	3 3-10	High Ta=+120℃ 5℃ Test Time=1,000hrs	0/22
Low Temperature Storage	JIS-C-7021 :B	3-12	Low Ta=-40℃ 5℃ Test Time=1,000hrs	0/22

<sup>\*</sup>Failure Criteria:

- 1. VF arise  $\geq 10\%$
- 2. IV decline  $\geq 30\%$
- 3. A failure is an LED that is open or shorted



# **HUEY JANN ELECTRONICS INDUSTRY CO., LTD.**

# **PRELIABILITY TEST**

## > Environmental Test

Test Item	Reference Standard	Test Conditions	Result
	MIL-STD-202:107D	-40°C ~ +25°C ~ +85°C ~ +25°C	
Temperature	MIL-STD-750:1051	60min 20min 60min 20min	0/22
Cycling	MIL-STD-883:1010		0/22
	JIS-C-7021 :A-4	Test Time=200cycle	
Thermal	MIL-STD-202:107D	-40°C 5°C ~+110°C 5°C	
	MIL-STD-750:1051	20min 20min	0/22
Shock	MIL-STD-883:1010	Test Time=200cycle	

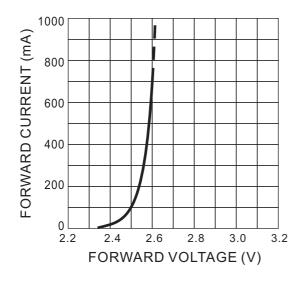
<sup>\*</sup>Failure Criteria:

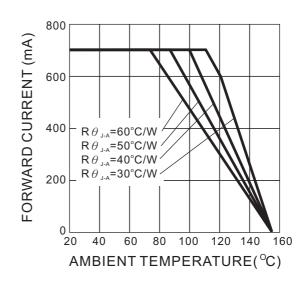
- 1. VF arise ≥ 10%
- 2. IV decline  $\geq 30\%$
- 3. A failure is an LED that is open or shorted

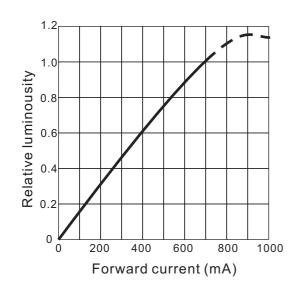


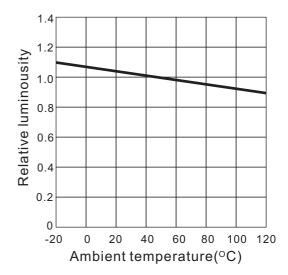
# HUEY JANN ELECTRONICS INDUSTRY CO., LTD.

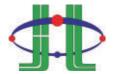
#### **TYPICAL ELECTRICAL OPTICAL CHARACTERISTICS CURVES**





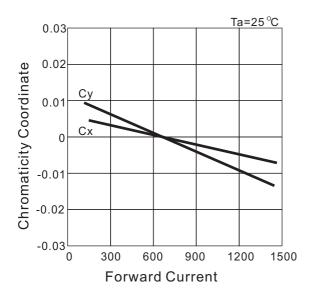


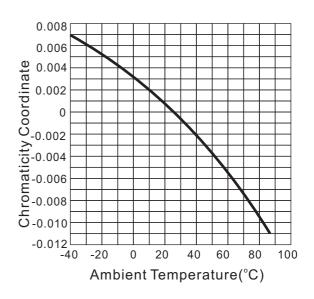


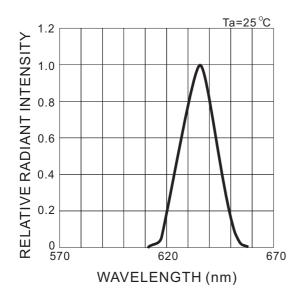


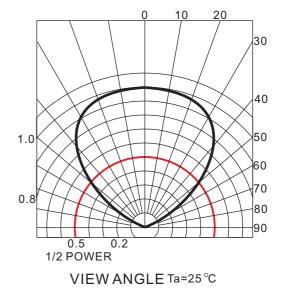
# **HUEY JANN ELECTRONICS INDUSTRY CO., LTD.**

## **TYPICAL ELECTRICAL OPTICAL CHARACTERISTICS CURVES**











# **HUEY JANN ELECTRONICS INDUSTRY CO., LTD.**

# **Brightness Bin Selection**

BIN CODE	Brightness in Im			
	Minimum	Maximum		
L	85	110		

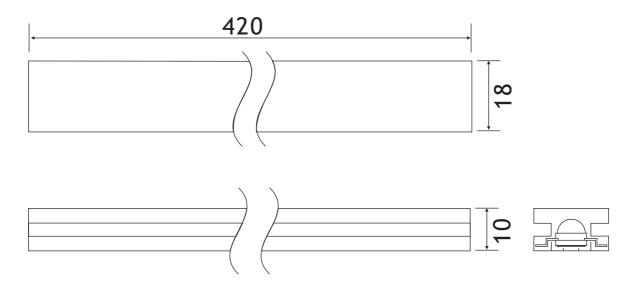
## NOTE:

1. Test Condition at IF=700mA.



# HUEY JANN ELECTRONICS INDUSTRY CO., LTD.

# Package Dimension For Emitter Type



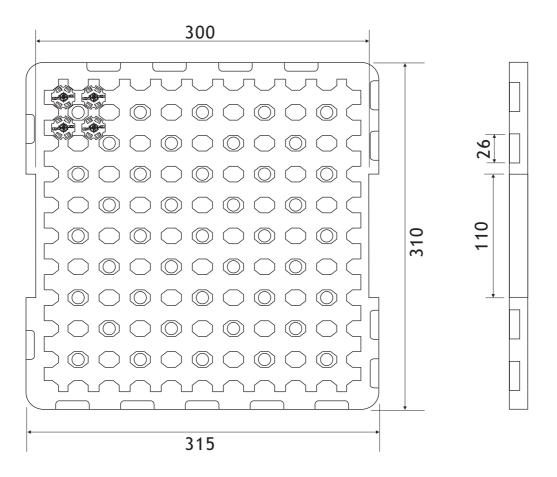
#### NOTE:

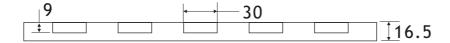
- 1. Dimensions are specified as follows: mm.
- 2. Tolerance is 0.3mm unless otherwise noted.
- 3. 50 pcs emitters per tube.
- 4. 80 tubes per inside box.
- 5. 4 inside box per outside box.



## **HUEY JANN ELECTRONICS INDUSTRY CO., LTD.**

# Package Dimension For Star Type





#### NOTE:

- 1. Dimensions are specified as follows: mm.
- 2. Tolerance is 0.3mm unless otherwise noted.
- 3. 100pcs star per tray.
- 4. 10 trays per box.

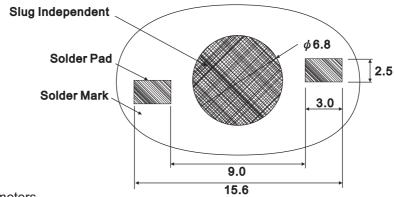


# **HUEY JANN ELECTRONICS INDUSTRY CO., LTD.**

# Requirements to user For Emitter Type

The LED products by HUEY-JANN is designed, manufactured, and sold aiming at high standard quality and reliability, however, reliability of electronic apparatus is seen as a product of reliability superior to HUEY-JANN and using status at users. From this point, HUEY-JANN requests user's for following things.

## Recommended Solder Pad Design For Emitter Type



Note:

- 1.All dimensions are in millimeters.
- 2. Electrical isolation is required between Slug and Solder Pad.



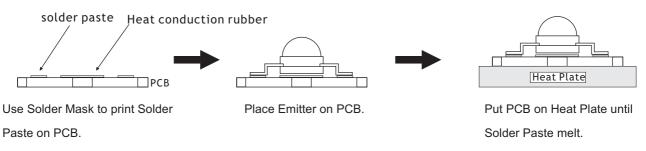
# **HUEY JANN ELECTRONICS INDUSTRY CO., LTD.**

No.27 Line 466 Sec.2, Canng-nan Rd. Wu-chi Town Taichung Shien, Taiwan, R.O.C.

TEL:+886-4-26393976 FAX:+886-4-26393125

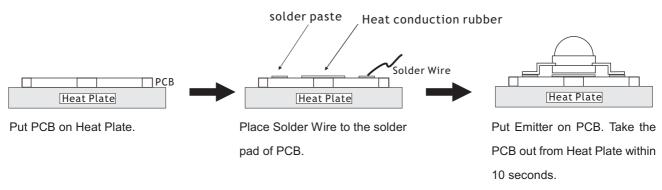
# Heat Plate Soldering Condition For Emitter Type

#### a. Soldering Process for Solder Paste



- 1. The Solder Paste sould be melted within 10 seconds.
- 2. Take out PCB out from Heat Plate within 15 seconds.

#### b. Soldering Process for Solder Wire



#### NOTE:

- 1.Heat plate temperature: 230°C max for Lead Solder and 260°C max for Lead-Free Solder.
- 2. When soldering, do not put stress on the LEDs during heating.
- 3. After soldering, do not warp the circuit board.

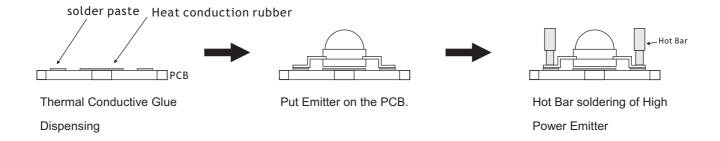


## **HUEY JANN ELECTRONICS INDUSTRY CO., LTD.**

No.27 Line 466 Sec.2, Canng-nan Rd. Wu-chi Town Taichung Shien, Taiwan, R.O.C.

TEL:+886-4-26393976 FAX:+886-4-26393125

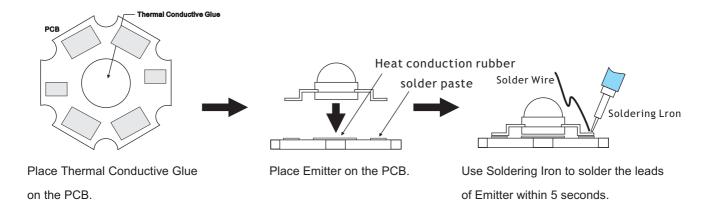
# Soldering Process For Hot Bar For Emitter Type



#### NOTE:

- 1.Hot Bar temperature: 230°C max for Lead Solder and 260°C max for Lead-Free Solder.
- 2. When soldering, do not put stress on the LEDs during heating.
- 3. After soldering, do not warp the circuit board.

## Manual Hand Soldering For Emitter Type



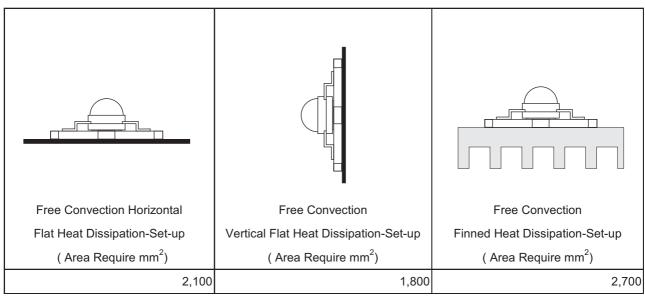
- 1.Solder tip temperature: 230°C max for Lead Solder and 260°C max for Lead-Free Solder.
- 2. Avoiding damage to the emitter or to the PCB dielectric layer. Damage to the epoxy layer can cause
- 3.Do not let the solder contact from solder pad to back-side of PCB. This one will cause a short circuit and damage emitter.



## **HUEY JANN ELECTRONICS INDUSTRY CO., LTD.**

#### Conclusion

Huey Jann provide simple comparison table for High Power LED, you could find your request heat dissipation area from the following table.



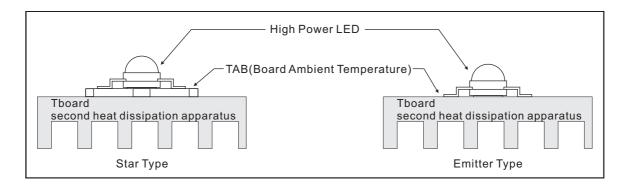
<sup>\*</sup>TAB in this table is according to highest operating temperature 65°C.

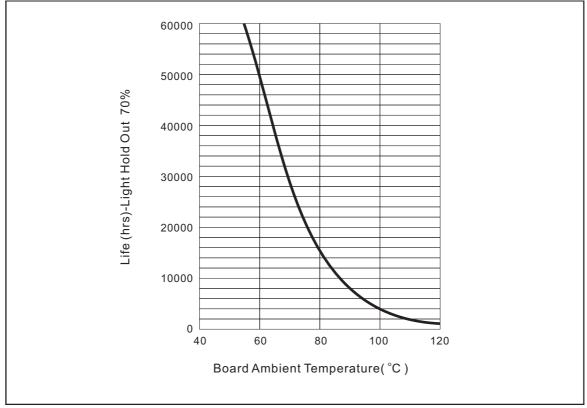


## **HUEY JANN ELECTRONICS INDUSTRY CO., LTD.**

<sup>\*</sup>Different materials of second heat dissipation device, the surface area of heat sink will be different. Thus, this document is for reference only.

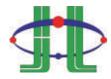
# **TAB Temperature - Life Characteristics Curves**





<sup>\*</sup>Board Ambient Temperature Tolerance 5°C.

<sup>\*</sup>Different materials of second heat dissipation device, the surface area of heat sink will be different. Thus, this document is for reference only.



## **HUEY JANN ELECTRONICS INDUSTRY CO., LTD.**

<sup>\*</sup>TAB in this table is according to highest operating temperature 65°C.

<sup>\*</sup>The TAB is the stable testing value for the product lighted 100% after one hour.

#### Remarks:

- 1. Brightness values are measured during a current pulse of typical 25 ms, the brightness tolerance is ±15%.
- 2. Dominant wavelength are measured during a current pulse of typical 200 ms, the chromaticity tolerance is  $\pm 1.0$ nm.
- 3. Forward voltage are measured during a current pulse of typical 5 ms, the VF tolerance is ±0.15V.
- 4. Dimensions are specified as follows: mm.
- 5. Related technical parameters of LED are average value resulted from statistic. The actual parameters of LED could be slightly different from average and characteristic curve.
- 6. The average value of LED will be changed by technical improvement and elevation, and subject to change without prior notice.
- 7. Hi-Power LED can not be operated without second heat dissipating structure.
- 8. Poor or damaged second heat dissipating structure could lead to defective electrical characteristic of High Power LED, CCT escalation, brightness drop, lifetime shortening or burn out. Following instructions of Huey Jann Hi-Power LED series document can avoid LED burn out and electrical defectiveness due to improper usage, and maintain normal performance of the products.



#### **HUEY JANN ELECTRONICS INDUSTRY CO., LTD.**